

FDC6901L Integrated Load Switch

Features

- Three Programmable Slew Rates
- Reduces Inrush Current
- Minimizes EMI
- Normal Turn-Off Speed
- Low-Power CMOS Operates Over Wide Voltage Range
- High Performance Trench Technology for Extremely low R_{DS(ON)}
- RoHS Compliant

Applications

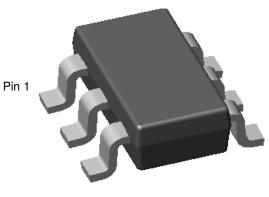
- Load switch
- Power management



February 2008

General Description

This device is particularly suited for compact power management. In portable electronic equipment where 2.5V to 6V input capability is needed. This load switch integrates a Slew Rate Control Driver that drives a P-Channel Power MOSFET in one tiny SuperSOTTM-6 package. The integrated slew rate control driver is specifically designed to control the turn on of the P-Channel MOSFET in order to limit the inrush current in battery switching applications with high capacitance loads. For turn-off, the IC pulls the MOSFET gate up quickly.

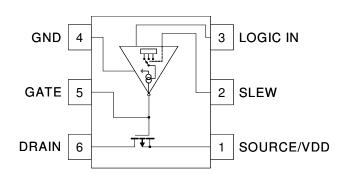


SuperSOT[™]-6

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
.901	FDC6901L	7"	8mm	3000 units

Pin Configuration



Absolute Maximum Ratings

Parameter	Min.	Max.	Unit
Supply Voltage	-0.5	10	V
DC Input Voltage (Logic Inputs)	-0.7	9	V
Power Dissipation			
Storage Junction Temperature	-55	150	°C
Thermal Resistance, Junction to Ambient		180	°C/W
Thermal Resistance, Junction to Case		60	℃/W

Recommended Operating Range

Parameter	Min.	Max.	Unit
Supply Voltage	2.7	6	V
Operating Junction Temperature	-55	150	S

Electrical Characteristics

 $T_A = 25 \,^{\circ}C$ unless otherwise noted

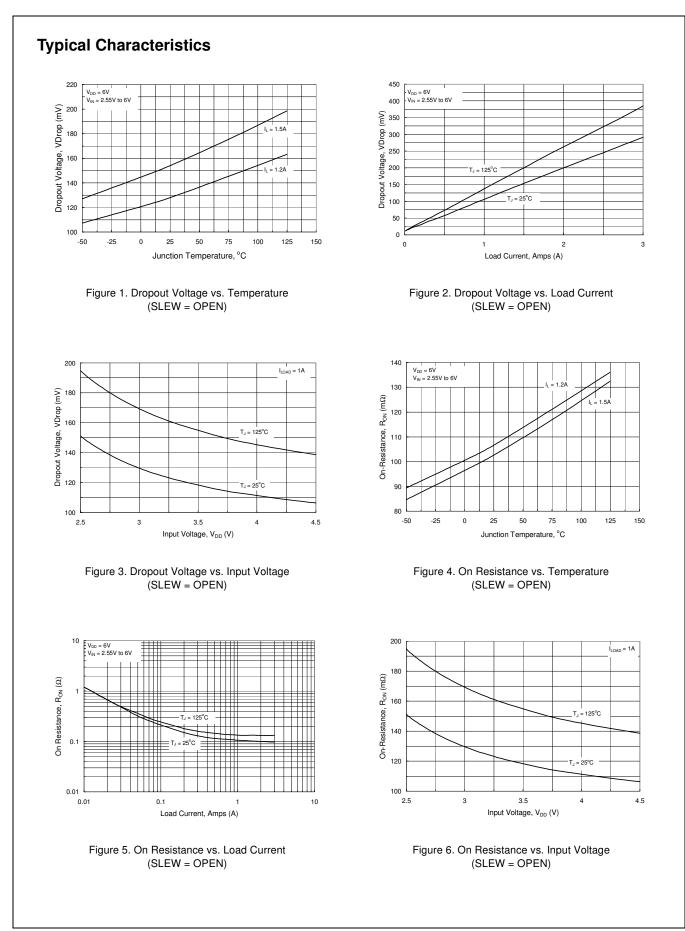
Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
Logic Levels	I	I				•	
Logic High Input Voltage	V _{IH}	V _{DD} = 2.7V to 6.0V		70% V _{DD}			V
Logic Low Input Voltage	V _{IL}	$V_{DD} = 2.7V \text{ to } 6.0V$				25% V _{DD}	V
Off Characteristics - Slew Rate C	ontrol Driver				•		
Supply Input Breakdown Voltage	BV _{DG}	$I_{DG} = 10 \mu A$, $V_{IN} = 0V$, $V_{SLEW} = 0V$		9			V
Slew Input Breakdown Voltage	BV _{SLEW}	$I_{SLEW} = 10\mu A, V_{IN} = 0V$		9			V
Logic Input Breakdown Voltage	BV _{IN}	$I_{IN} = 10\mu A, V_{SLEW} = 0V$		9			V
Supply Input Leakage Current	IR _{DG}	$V_{DG} = 8V, V_{IN} = 0V, V_{SLEW} = 0V$				100	nA
Slew Input Leakage Current	IR _{SLEW}	$V_{SLEW} = 8V, V_{IN} = 0V$				100	nA
Logic Input Leakage Current	IR _{IN}	$V_{IN} = 8V, V_{SLEW} = 0V$				100	nA
Off Characteristics - Slew Rate C	ontrol Driver +	P-Channel MOS	FET		•		
MOSFET Breakdown Voltage	BV _{DSS}	I _D = -250μA		9			V
MOSFET Leakage Current	I _{DSS}	V _R = 16V				100	nA
On Characteristics - Slew Rate Co	ontrol Driver				•		
			Slew Pin = Open	90			μA
Output/Gate Current	I _G	Ι _D = -250μΑ	Slew Pin = GND	1			μA
			Slew Pin = V _{DD}	10			nA

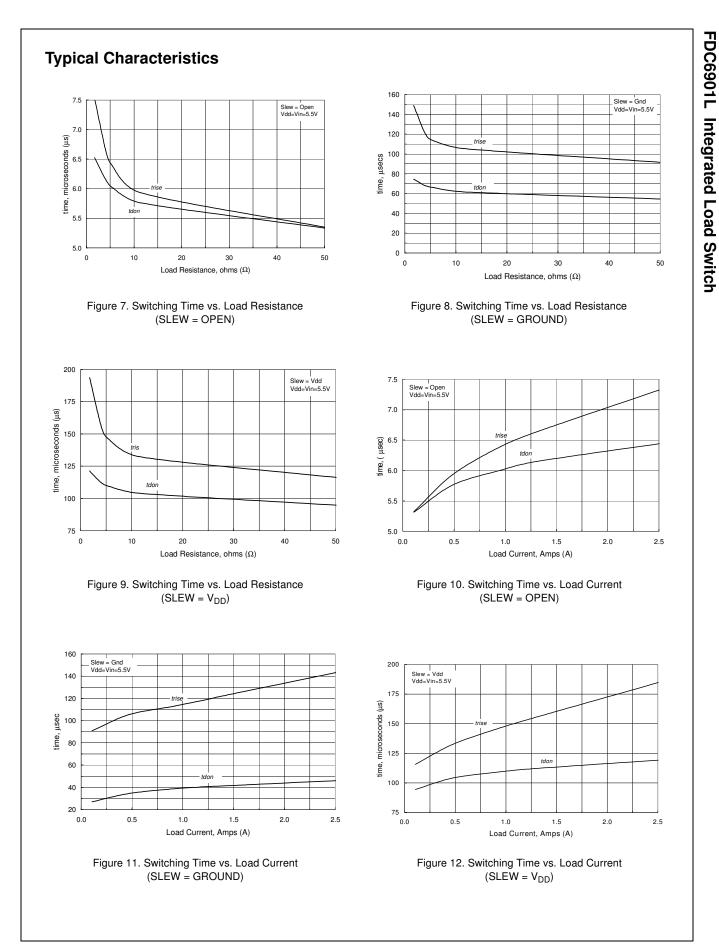
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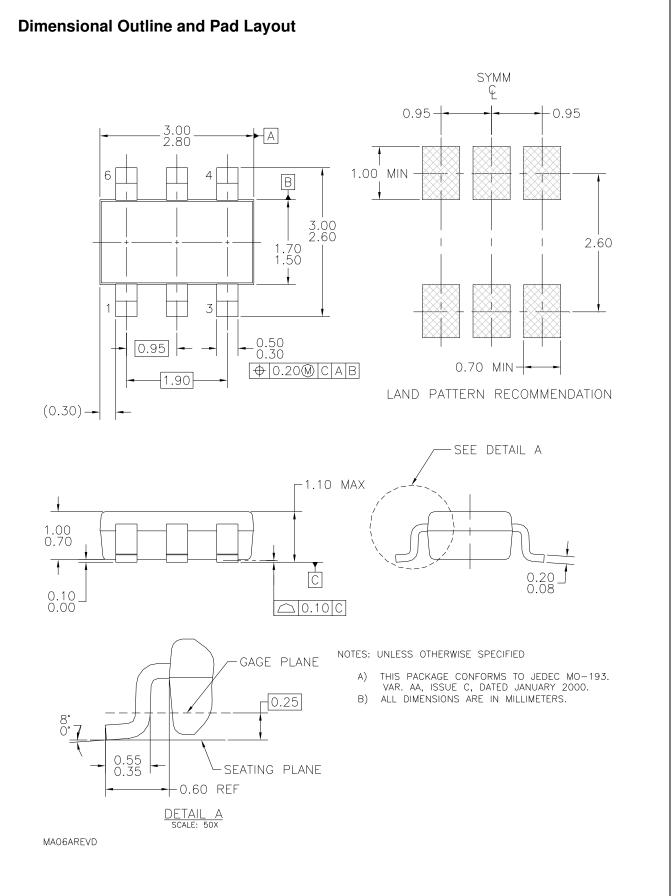
Electrical Characteristics Cont.

 $T_A = 25 \,^{\circ}C$ unless otherwise noted

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
On Characteristics - P-Channel MC	SFET	•					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250\mu A$		-0.6	-1	-1.5	V
Static Drain-Source On Resistance		$V_{GS} = -4.5V, I_D = -$	1.5A		120	145	mΩ
Static Drain-Source On Resistance	R _{DS(ON)}	V _{GS} = -2.5V, I _D = -1.2A			170	210	mΩ
On Characteristics - Slew Rate Co	ntrol Driver +	P-Channel MOSFE	т				
Dropout Voltage	V _{DROP}	$V_{DD} = 6V$, $V_{IN} = 2.5V$ to $6V$, $I_L = 1.5A$			160	300	mV
Diopout voltage		$V_{DD} = 6V, V_{IN} = 2.5V \text{ to } 6V, I_L = 1.2A$			130	300	mV
Load Switch On Resistance	R _{ON}	$V_{DD} = 6V, V_{IN} = 2.5V \text{ to } 6V, I_{L} = 1.5A$			105	180	mΩ
Load Switch On Resistance		$V_{DD} = 6V, V_{IN} = 2.5V \text{ to } 6V, I_{L} = 1.2A$			110	210	mΩ
Load Current	I _{LOAD}	$V_{GS} = 2.5 \text{ V}, V_{DS} = 6 \text{ V}$		3			А
P-Channel Switching Times $(V_{SUPF}$	_{PLY} = 5.5V, V _{DI}	$_{\rm D}$ = 5.5V, Logic IN =	5.5V, I _{LOAD} = 1.5A)				
			= Open		6.2		μs
Delay On Time	td _{ON}	Slew Pin	= GND		42		μs
			= V _{DD}		115		μs
			= Open		6.75		μs
V _{OUT} Rise Time	t _R	Slew Pin	= GND		124		μs
			= V _{DD}		162		μs
			= Open		600		V/ms
Output Slew Rate	dv/dt	Slew Pin	= GND		41		V/ms
			= V _{DD}		24		V/ms









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